9 CLK

- Four J-K Flip-Flops in a Single Package . . .
  Can Reduce FF Package Count by 50%
- Common Positive-Edge-Triggered Clocks with Hysteresis . . . Typically 200 mV
- Fully Buffered Outputs
- Typical Clock Input Frequency . . . 45 MHz

### description

These quadruple TTL J-K flip-flops incorporate a number of third-generation IC features that can simplify system design and reduce flip-flop package count by as much as 50%. They feature hysteresis at the clock input, fully buffered outputs, and direct clear capability. The positive-edge-triggered SN54376 and SN74376 are directly compatible with most Series 54/74 MSI registers.

The SN54376 is characterized for operation over the full military temperature range of -55°C to 125°C; the SN74376 is characterized for operation from 0°C to 70°C.

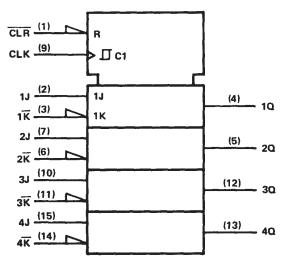
#### FUNCTION TABLE (EACH FLIP-FLOP)

COMMO	INP	UTS	OUTPUT	
CLEAR	CLOCK	J	ĸ	a
L	Х	X	Х	L
Н	<b>†</b>	L	H	$\sigma_0$
Н	<b>†</b>	Н	н	н
н	<b>†</b>	L	L	L
н	†	. н	L	TOGGLE
Н	L	×	×	$a_0$

#### SN54376 . . . J PACKAGE SN74376 . . . N PACKAGE (TOP VIEW) CLR 1 U16 VCC 15 🛮 4J 1J 🔲 2 1K □3 14 4K 10 4 13 **4**0 20.05 12 3Q 2K □ 6 11 □3K 2J 🛮 7 10 **3**J

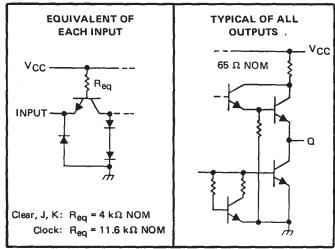
GND □8

### logic symbol†



<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

#### schematics of inputs and outputs



Resistor values shown are nominal.

TEXAS INSTRUMENTS

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		7 V
Input voltage		5.5 V
Operating free-air temperature range:	SN54376	55°C to 125°C
operating mee an emperation and	SN74376	0°C to 70°C

NOTE 1: Voltage values are with respect to network ground terminals.

### recommended operating conditions

		SN54376		SN74376			LINUT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V	
High-level output cur				-800			-800	μΑ	
Low-level output cur	rent, IOL			16			16	mA	
Clock frequency		0		30	0		30	MHz	
	Clock high	22			22				
Pulse width, tw	Clock low	12			12			ns	
	Preset or clear low	12			12				
Setup time, t <sub>SU</sub>	J, K inputs	01			01			ns	
	Clear inactive state	10↑			101			113	
Input hold time, th		201			20↑			ns	
Operating free-air temperature, TA		-55		125	0		70	°c	

<sup>↑↓</sup>The arrow indicates the edge of the clock pulse used for reference: ↑ for the rising edge, ↓ for the falling edge,

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2			V
VIL	Low-level input voltage					8.0	V
VIK	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>I</sub> = -12 mA			-1.5	V
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = 0.8 V,	V <sub>1H</sub> = 2 V, I <sub>OH</sub> = -800 μA	2.4	3,4		٧
VOL	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = 0.8 V,	V <sub>IH</sub> = 2 V, I <sub>OL</sub> = 16 mA		0.2	0.4	٧
I <sub>I</sub>	Input current at maximum input voltage	VCC = MAX,	V <sub>I</sub> = 5.5 V			1	mA
Тін	High-level input current	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.4 V			40	μΑ
TIL	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V			-1.6	mA
los	Short-circuit output current§	V <sub>CC</sub> = MAX		-30		-85	mA
Icc	Supply current	V <sub>CC</sub> = MAX			52	74	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub>	Maximum clock frequency	C: = 15 aF	30	45		MHz
tPHL	Propagation delay time, high-to-low-level output from clear	$C_L = 15 \text{ pF},$ $R_L = 400 \Omega,$		17	30	ns
tPLH	Propagation delay time, low-to-high-level output from clock	See Note 2		22	35	ns
tPHL	Propagation delay time, high-to-low-level output from clock	See Note 2		24	35	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>^{\</sup>ddagger}$ Ail typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}$ C.

Not more than one output should be shorted at a time.





i.com 18-Sep-2008

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN54376J	OBSOLETE	CDIP	J	16	TBD	Call TI	Call TI
SN74376N	OBSOLETE	PDIP	N	16	TBD	Call TI	Call TI
SN74376N	OBSOLETE	PDIP	N	16	TBD	Call TI	Call TI
SNJ54376J	OBSOLETE	CDIP	J	16	TBD	Call TI	Call TI
SNJ54376J	OBSOLETE	CDIP	J	16	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

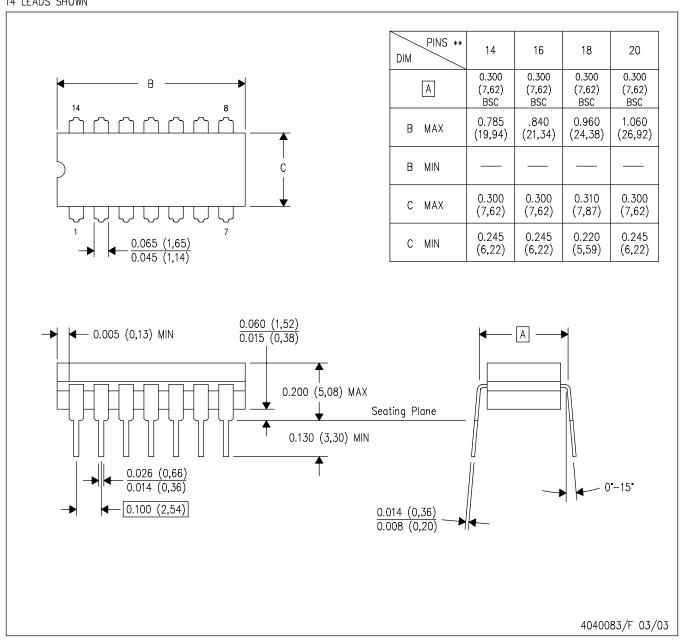
**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

# 14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



#### IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DLP® Products	www.dlp.com	Communications and Telecom	www.ti.com/communications
DSP	<u>dsp.ti.com</u>	Computers and Peripherals	www.ti.com/computers
Clocks and Timers	www.ti.com/clocks	Consumer Electronics	www.ti.com/consumer-apps
Interface	interface.ti.com	Energy	www.ti.com/energy
Logic	logic.ti.com	Industrial	www.ti.com/industrial
Power Mgmt	power.ti.com	Medical	www.ti.com/medical
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
RFID	www.ti-rfid.com	Space, Avionics & Defense	www.ti.com/space-avionics-defense
RF/IF and ZigBee® Solutions	www.ti.com/lprf	Video and Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless-apps